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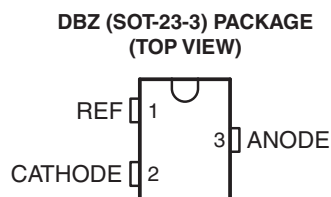
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ADJUSTABLE PRECISION SHUNT REGULATORS

Check for Samples: [TL432A-Q1](#), [TL432B-Q1](#)

FEATURES

- Qualified for Automotive Applications
- AEC-Q100 Qualified With the Following Results:
 - Device Temperature Grade 1: –40°C to 125°C Ambient Operating Temperature Range
 - Device HBM ESD Classification Level H2
 - Device CDM ESD Classification Level C3B
- Operation From –40°C to 125°C
- Reference Voltage Tolerance at 25°C
 - 0.5%...B Grade
 - 1%...A Grade
- Typical Temperature Drift...14 mV
- Low Output Noise
- Typical Output Impedance...0.2 Ω
- Sink Current Capability...1 mA to 100 mA
- Adjustable Output Voltage... V_{ref} to 36 V



DESCRIPTION/ORDERING INFORMATION

The TL432x-Q1 devices are three-terminal adjustable shunt regulators with specified thermal stability over the automotive temperature range. The output voltage can be set to any value between V_{ref} (approximately 2.5 V) and 36 V with two external resistors (see [Figure 17](#)). These devices have a typical output impedance of 0.2 Ω. Active output circuitry provides a very sharp turn-on characteristic, making these devices excellent replacements for Zener diodes in many applications such as onboard regulation, adjustable power supplies, and switching power supplies.

The TL432x-Q1 devices are offered in two grades with initial tolerances (at 25°C) of 0.5% and 1%, for the B and A grade, respectively. In addition, low output drift vs temperature ensures good stability over the entire temperature range.

The devices are characterized for operation from –40°C to 125°C.

ORDERING INFORMATION⁽¹⁾

T_A	V_{ref} TOLERANCE ($T_A = 25^\circ\text{C}$)	PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	A Grade: 1%	SOT23 – DBZ	Reel of 3000	TL432AQDBZRQ1	TOIQ
	B Grade: 0.5 %			TL432BQDBZRQ1	TOHQ

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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TL432A-Q1
TL432B-Q1

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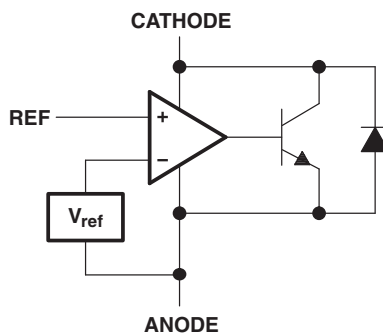
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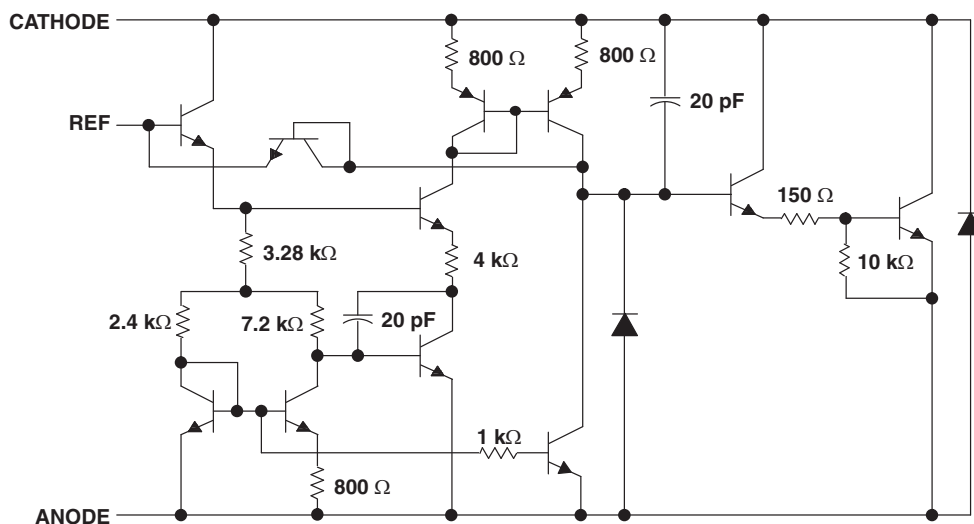
SYMBOL



FUNCTIONAL BLOCK DIAGRAM



EQUIVALENT SCHEMATIC



NOTE: All component values are nominal.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

V_{KA}	Cathode voltage ⁽²⁾	37 V
I_{KA}	Continuous cathode current range	–100 mA to 150 mA
	Reference input current range	–50 μ A to 10 mA
T_J	Operating virtual-junction temperature	150°C
T_{stg}	Storage temperature range	–65°C to 150°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Voltage values are with respect to the ANODE terminal, unless otherwise noted.

PACKAGE THERMAL DATA

PACKAGE	BOARD	θ_{JC}	θ_{JA}
SOT-23-3 (DBZ)	High K, JESD 51-7	76°C/W	206°C/W

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V_{KA}	Cathode voltage	V_{ref}	36	V
I_{KA}	Cathode current	1	100	mA
T_A	Operating free-air temperature	–40	125	°C
ESD Ratings	Human-body model (HBM) AEC-Q100 classification level H2		2	kV
	Charged-device model (CDM) AEC-Q100 classification level C3B		750	V

TL432A-Q1 TL432B-Q1

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TL432A-Q1 ELECTRICAL CHARACTERISTICS

over recommended operating conditions, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{ref} Reference voltage	Figure 2	$V_{KA} = V_{\text{ref}}, I_{KA} = 10\text{ mA}$	2470	2495	2520	mV
$V_{I(\text{dev})}$ Deviation of reference voltage over full temperature range (see Figure 1)	Figure 2	$V_{KA} = V_{\text{ref}}, I_{KA} = 10\text{ mA}, T_A = -40^\circ\text{C}$ to 125°C		14	34	mV
$\frac{\Delta V_{\text{ref}}}{\Delta V_{KA}}$ Ratio of change in reference voltage to the change in cathode voltage	Figure 3	$I_{KA} = 10\text{ mA}$		-1.4	-2.7	mV/V
		$\Delta V_{KA} = 10\text{ V} - V_{\text{ref}}$				
		$\Delta V_{KA} = 36\text{ V} - 10\text{ V}$		-1	-2	
I_{ref} Reference current	Figure 3	$I_{KA} = 10\text{ mA}, R1 = 10\text{ k}\Omega, R2 = \infty$		2	4	μA
$I_{I(\text{dev})}$ Deviation of reference current over full temperature range (see Figure 1)	Figure 3	$I_{KA} = 10\text{ mA}, R1 = 10\text{ k}\Omega, R2 = \infty, T_A = -40^\circ\text{C}$ to 125°C		0.8	2.5	μA
I_{min} Minimum cathode current for regulation	Figure 2	$V_{KA} = V_{\text{ref}}$		0.4	0.7	mA
I_{off} Off-state cathode current	Figure 4	$V_{KA} = 36\text{ V}, V_{\text{ref}} = 0$		0.1	0.5	μA
$ z_{KA} $ Dynamic impedance (see Figure 1)	Figure 2	$I_{KA} = 1\text{ mA}$ to $100\text{ mA}, V_{KA} = V_{\text{ref}}, f \leq 1\text{ kHz}$		0.2	0.5	Ω

TL432B-Q1 ELECTRICAL CHARACTERISTICS

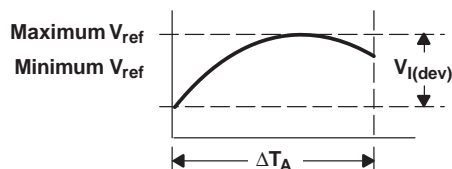
over recommended operating conditions, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CIRCUIT	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{ref} Reference voltage	Figure 2	$V_{KA} = V_{\text{ref}}, I_{KA} = 10\text{ mA}$	2483	2495	2507	mV
$V_{I(\text{dev})}$ Deviation of reference voltage over full temperature range (see Figure 1)	Figure 2	$V_{KA} = V_{\text{ref}}, I_{KA} = 10\text{ mA}, T_A = -40^\circ\text{C}$ to 125°C		14	34	mV
$\frac{\Delta V_{\text{ref}}}{\Delta V_{KA}}$ Ratio of change in reference voltage to the change in cathode voltage	Figure 3	$I_{KA} = 10\text{ mA}$		-1.4	-2.7	mV/V
		$\Delta V_{KA} = 10\text{ V} - V_{\text{ref}}$				
		$\Delta V_{KA} = 36\text{ V} - 10\text{ V}$		-1	-2	
I_{ref} Reference current	Figure 3	$I_{KA} = 10\text{ mA}, R1 = 10\text{ k}\Omega, R2 = \infty$		2	4	μA
$I_{I(\text{dev})}$ Deviation of reference current over full temperature range (see Figure 1)	Figure 3	$I_{KA} = 10\text{ mA}, R1 = 10\text{ k}\Omega, R2 = \infty, T_A = -40^\circ\text{C}$ to 125°C		0.8	2.5	μA
I_{min} Minimum cathode current for regulation	Figure 2	$V_{KA} = V_{\text{ref}}$		0.4	0.7	mA
I_{off} Off-state cathode current	Figure 4	$V_{KA} = 36\text{ V}, V_{\text{ref}} = 0$		0.1	0.5	μA
$ z_{KA} $ Dynamic impedance (see Figure 1)	Figure 2	$I_{KA} = 1\text{ mA}$ to $100\text{ mA}, V_{KA} = V_{\text{ref}}, f \leq 1\text{ kHz}$		0.2	0.5	Ω

Deviation Parameters

The deviation parameters $V_{\text{ref(dev)}}$ and $I_{\text{ref(dev)}}$ are defined as the differences between the maximum and minimum values obtained over the recommended temperature range. The average full-range temperature coefficient of the reference voltage, $\alpha_{V_{\text{ref}}}$, is defined as:

$$|\alpha_{V_{\text{ref}}}| \left(\frac{\text{ppm}}{^{\circ}\text{C}} \right) = \frac{\left(\frac{V_{\text{I(dev)}}}{V_{\text{ref at } 25^{\circ}\text{C}}} \right) \times 10^6}{\Delta T_A}$$



where:

ΔT_A is the recommended operating free-air temperature range of the device.

$\alpha_{V_{\text{ref}}}$ can be positive or negative, depending on whether minimum V_{ref} or maximum V_{ref} , respectively, occurs at the lower temperature.

Example: $V_{\text{ref}} = 2495 \text{ mV}$ at 25°C , $V_{\text{I(dev)}} = 14 \text{ mV}$, $\Delta T_A = 165^{\circ}\text{C}$ for TL432B

$$|\alpha_{V_{\text{ref}}}| = \frac{\left(\frac{14 \text{ mV}}{2495 \text{ mV}} \right) \times 10^6}{165^{\circ}\text{C}} \approx 34 \frac{\text{ppm}}{^{\circ}\text{C}}$$

Because minimum V_{ref} occurs at the lower temperature, the coefficient is positive.

Dynamic Impedance

The dynamic impedance is defined as: $|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{KA}}$

When the device is operating with two external resistors (see Figure 3), the total dynamic impedance of the circuit is given by:

$$|z'| = \frac{\Delta V}{\Delta I} \approx |z_{KA}| \left(1 + \frac{R1}{R2} \right)$$

Figure 1. Calculating Deviation Parameters and Dynamic Impedance

TL432A-Q1
TL432B-Q1

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PARAMETER MEASUREMENT INFORMATION

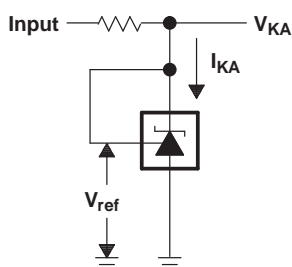


Figure 2. Test Circuit for $V_{KA} = V_{ref}$

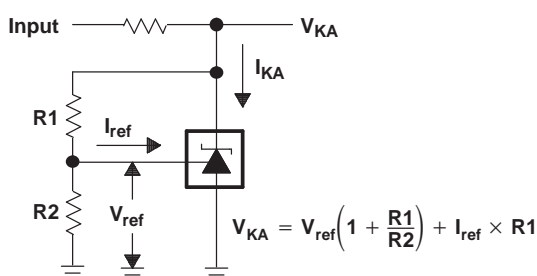


Figure 3. Test Circuit for $V_{KA} > V_{ref}$

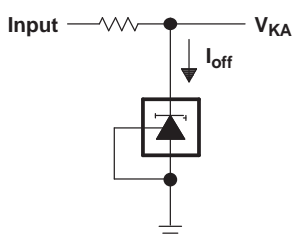


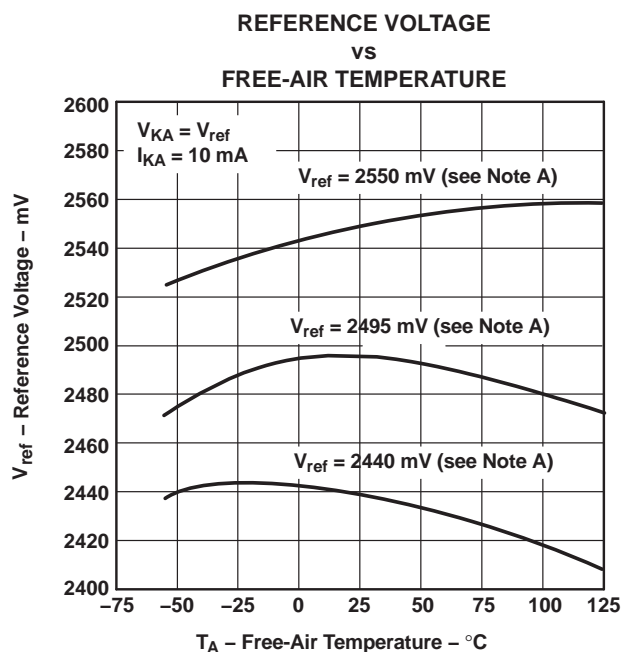
Figure 4. Test Circuit for I_{off}

TYPICAL CHARACTERISTICS

Data at high and low temperatures is applicable only within the recommended operating free-air temperature ranges of the various devices.

Table 1. Graphs

	FIGURE
Reference voltage vs Free-air temperature	Figure 5
Reference current vs Free-air temperature	Figure 6
Cathode current vs Cathode voltage	Figure 7, Figure 8
Off-state cathode current vs Free-air temperature	Figure 9
Ratio of delta reference voltage to delta cathode voltage vs Free-air temperature	Figure 10
Equivalent input noise voltage vs Frequency	Figure 11
Equivalent input noise voltage over a 10-s period	Figure 12
Small-signal voltage amplification vs Frequency	Figure 13
Reference impedance vs Frequency	Figure 14
Pulse response	Figure 15
Stability boundary conditions	Figure 16



A. Data is for devices having the indicated value of V_{ref} at $I_{KA} = 10 \text{ mA}$, $T_A = 25^\circ\text{C}$.

Figure 5.

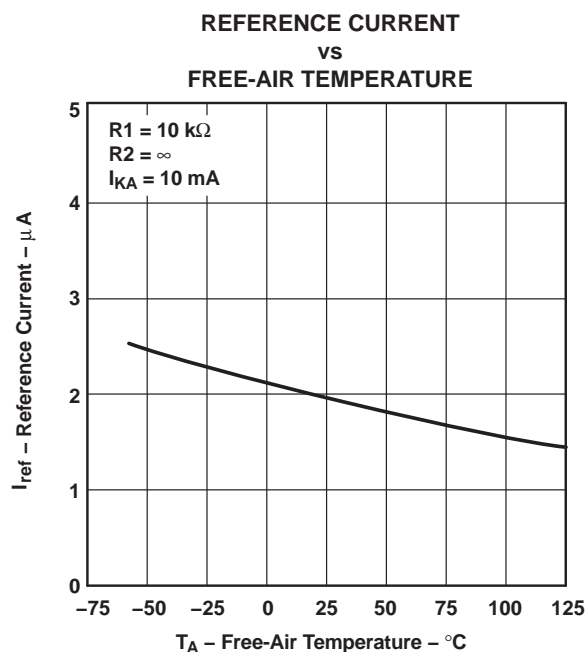
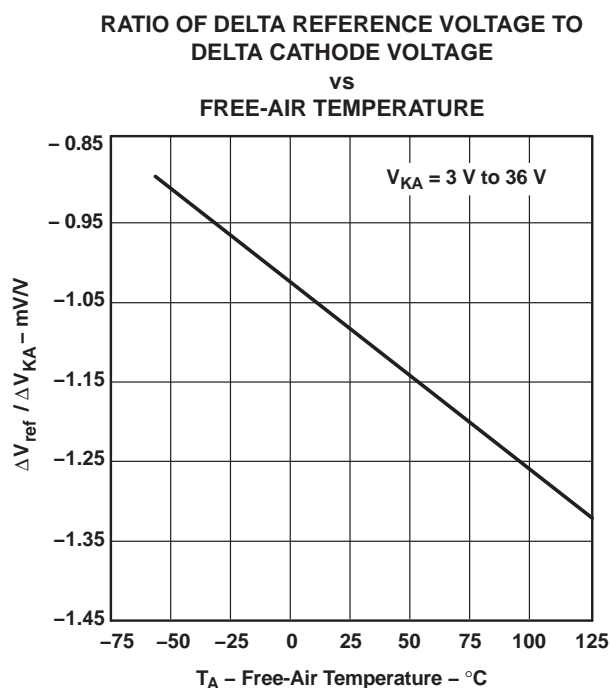
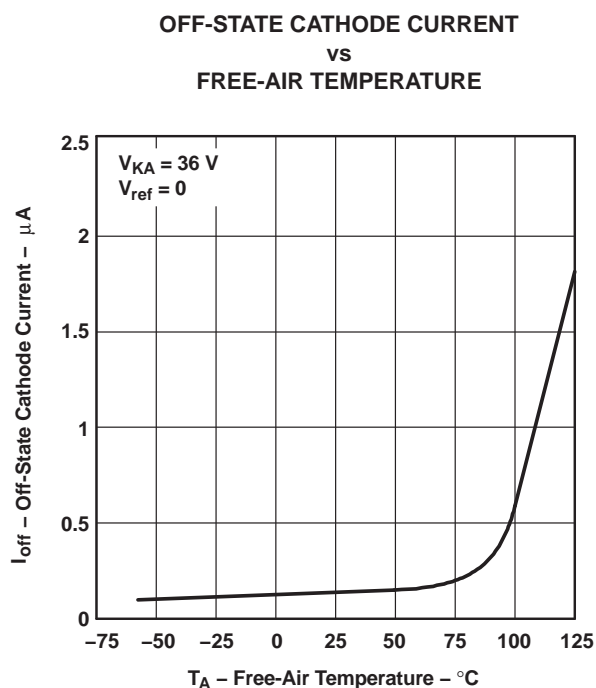
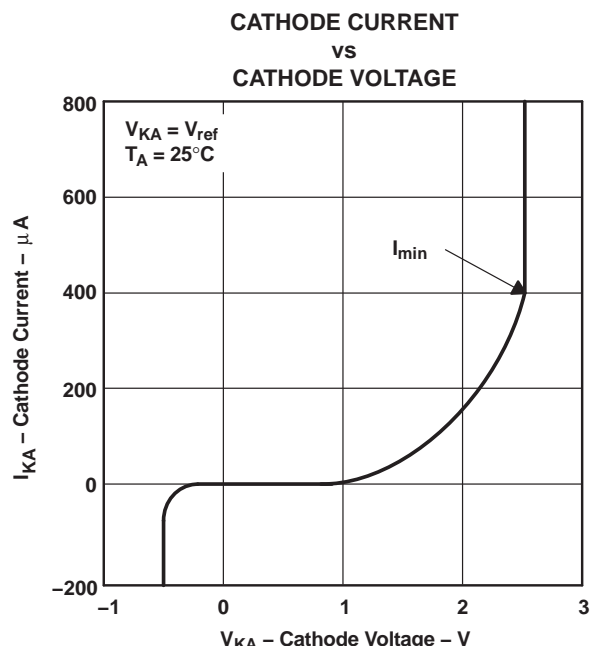
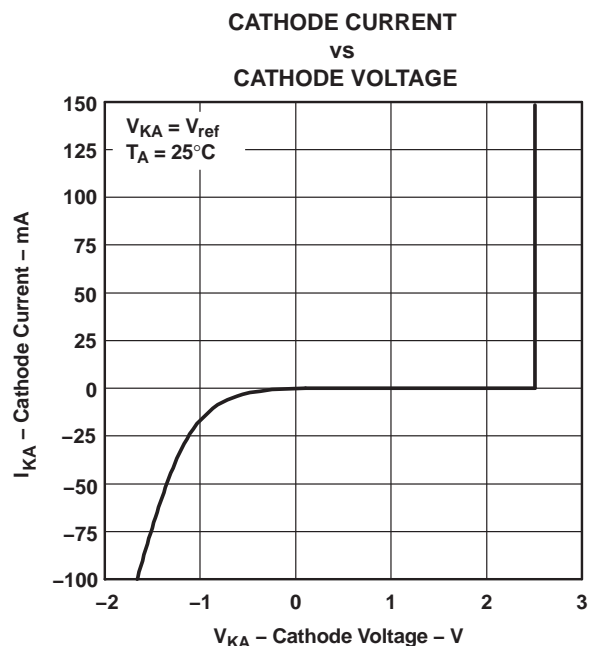


Figure 6.

**TL432A-Q1
TL432B-Q1**

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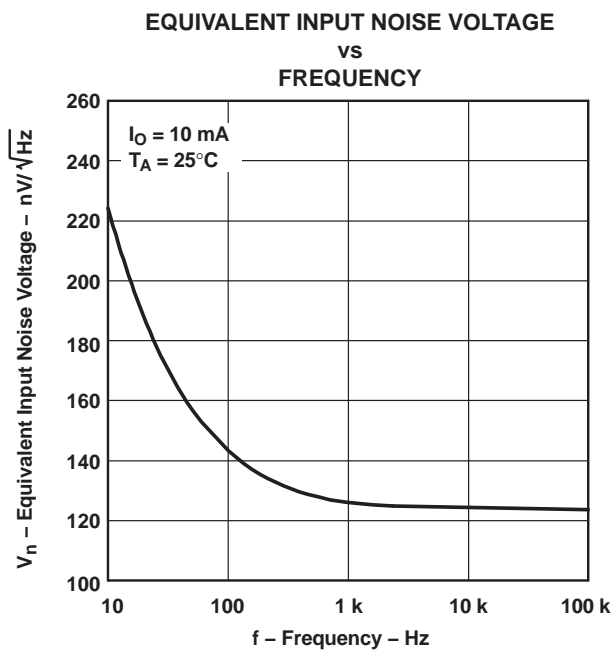


Figure 11.

TL432A-Q1
TL432B-Q1

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**EQUIVALENT INPUT NOISE VOLTAGE
OVER A 10-S PERIOD**

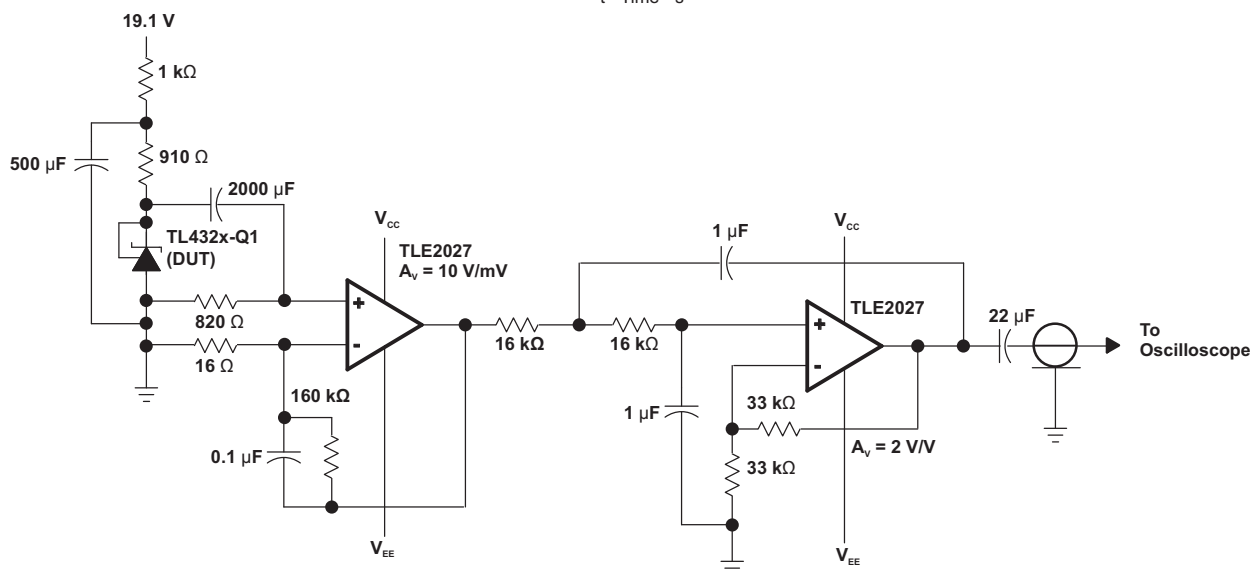
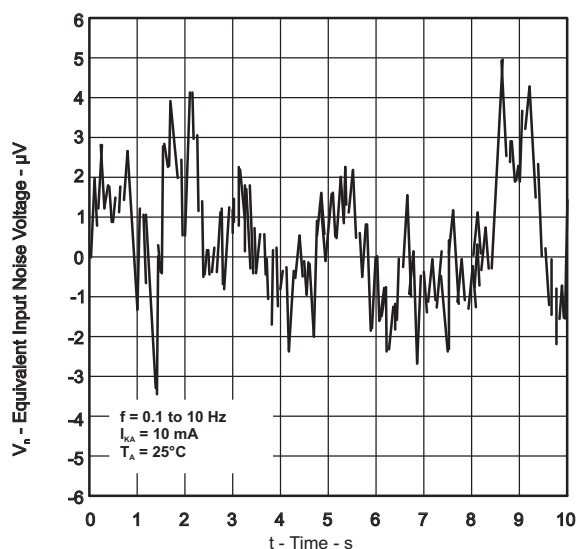


Figure 12. Test Circuit for Equivalent Input Noise Voltage

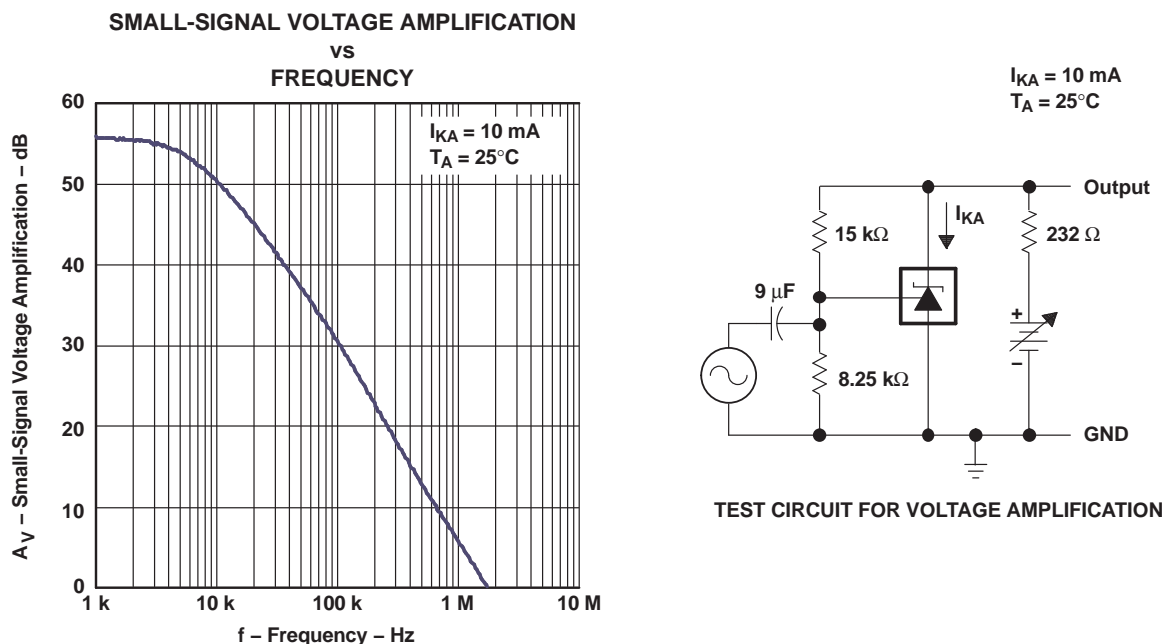


Figure 13.

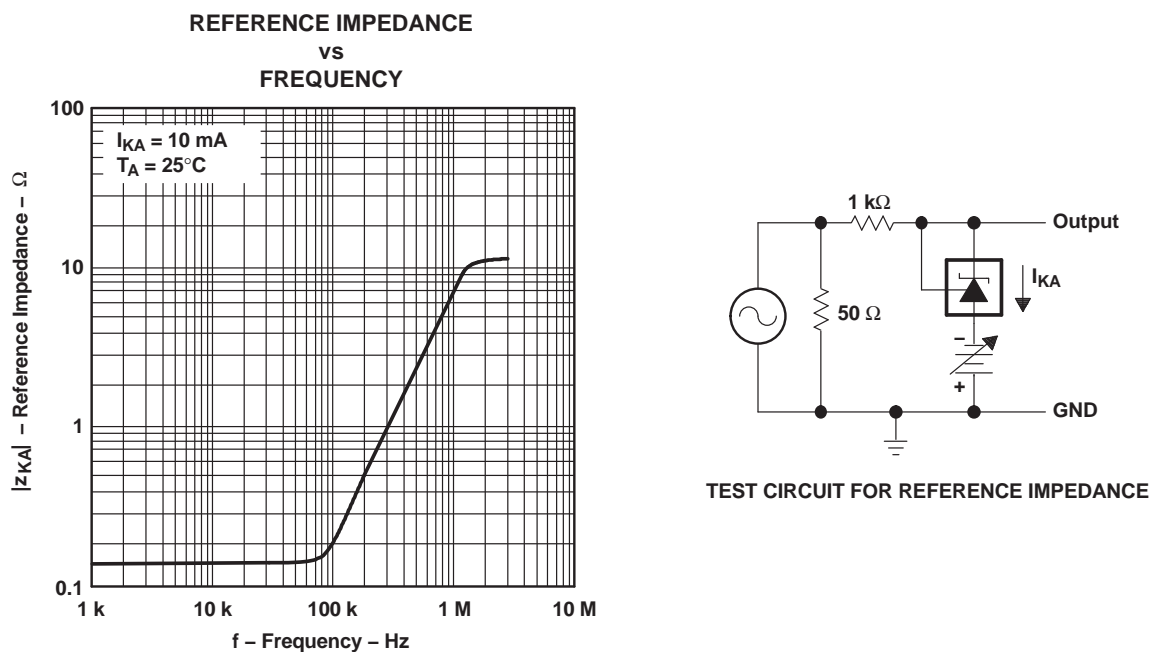
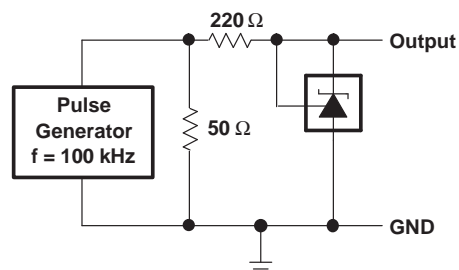
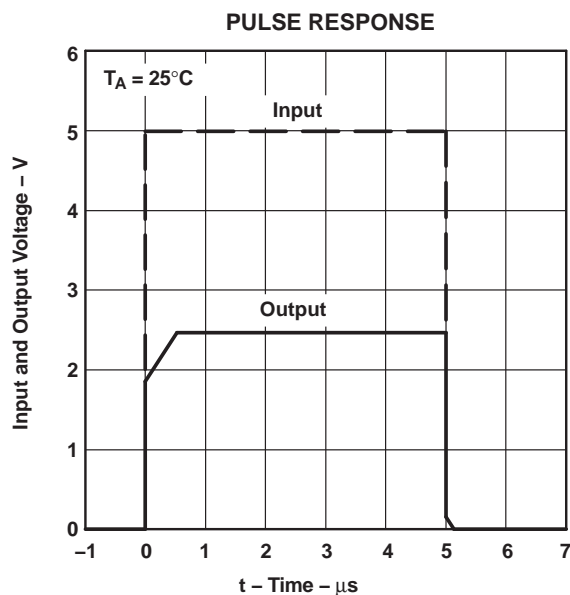


Figure 14.

TL432A-Q1
TL432B-Q1

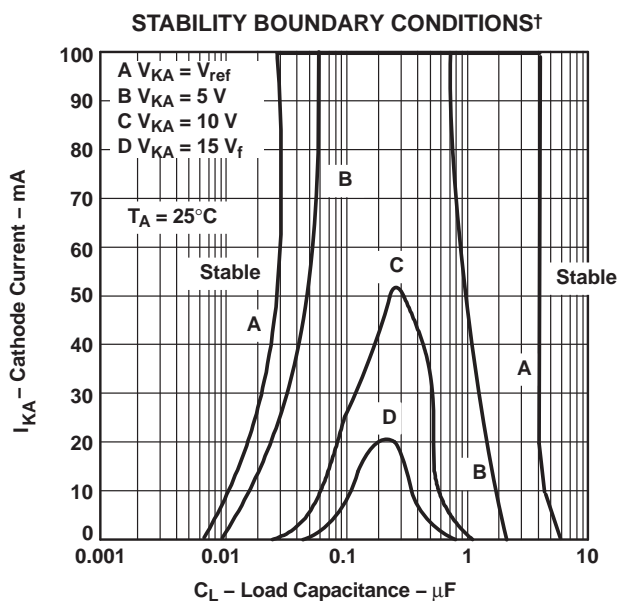
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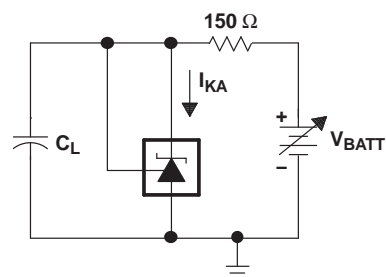


TEST CIRCUIT FOR PULSE RESPONSE

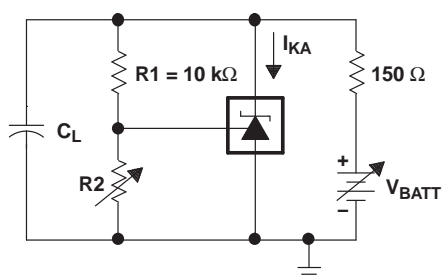
Figure 15.



† The areas under the curves represent conditions that may cause the device to oscillate. For curves B, C, and D, R2 and V+ were adjusted to establish the initial V_{KA} and I_{KA} conditions with $C_L = 0$. V_{BATT} and C_L then were adjusted to determine the ranges of stability.



TEST CIRCUIT FOR CURVE A



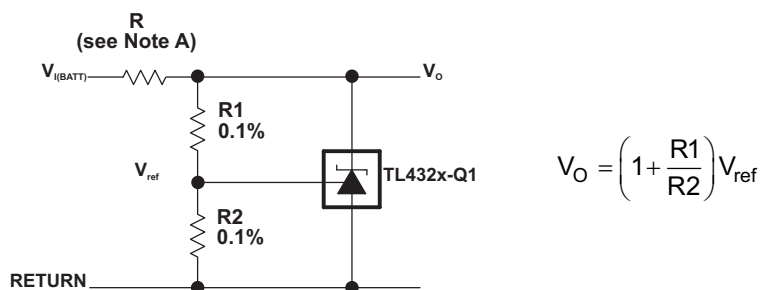
TEST CIRCUIT FOR CURVES B, C, AND D

Figure 16.

APPLICATION INFORMATION

Table 2. Application Circuits

	FIGURE
Shunt regulator	Figure 17
Single-supply comparator with temperature-compensated threshold	Figure 18
Precision high-current series regulator	Figure 19
Output control of a three-terminal fixed regulator	Figure 20
High-current shunt regulator	Figure 21
Crowbar circuit	Figure 22
Precision 5-V 1.5-A regulator	Figure 23
Efficient 5-V precision regulator	Figure 24
PWM converter with reference	Figure 25
Voltage monitor	Figure 26
Delay timer	Figure 27
Precision current limiter	Figure 28
Precision constant-current sink	Figure 29



A. R should provide cathode current ≥ 1 mA to the TL432x-Q1 at minimum $V_{I(BATT)}$.

Figure 17. Shunt Regulator

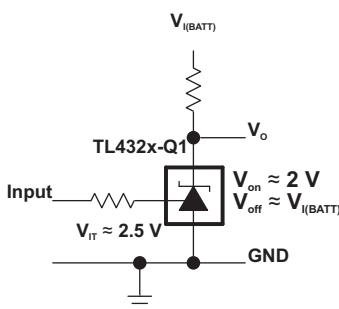
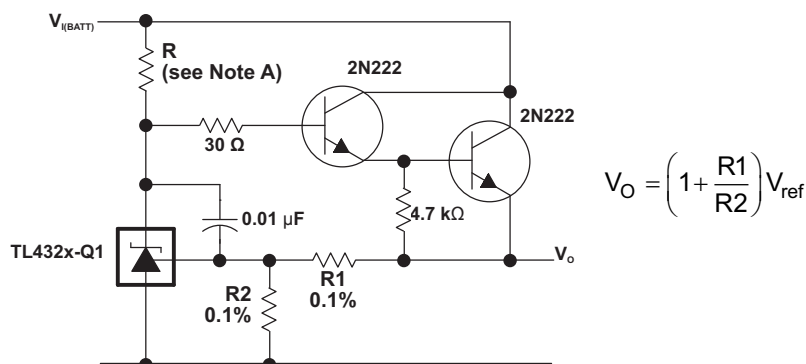


Figure 18. Single-Supply Comparator With Temperature-Compensated Threshold

TL432A-Q1
TL432B-Q1

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A. R should provide cathode current ≥ 1 mA to the TL432x-Q1 at minimum $V_{I(BATT)}$.

Figure 19. Precision High-Current Series Regulator

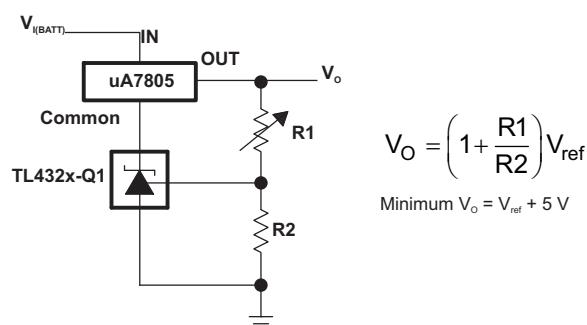


Figure 20. Output Control of a Three-Terminal Fixed Regulator

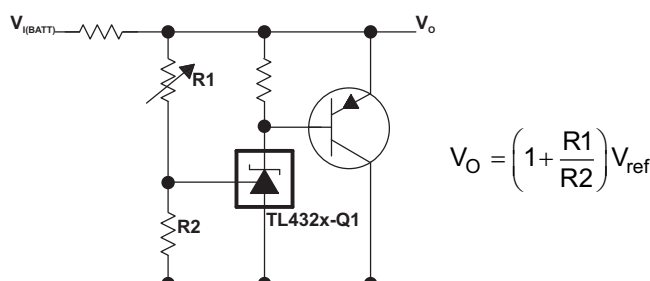
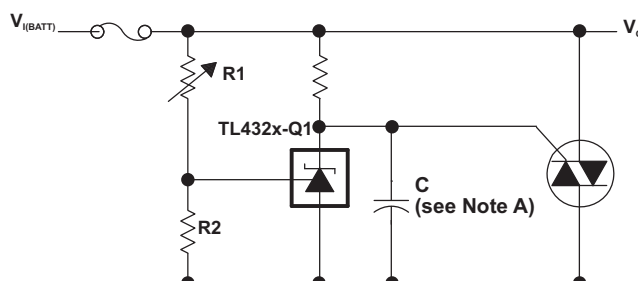


Figure 21. High-Current Shunt Regulator



A. See the stability boundary conditions in Figure 16 to determine allowable values for C.

Figure 22. Crowbar Circuit

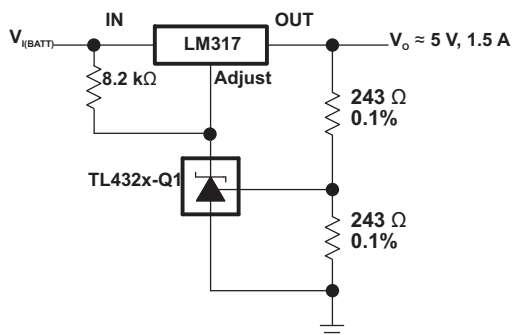
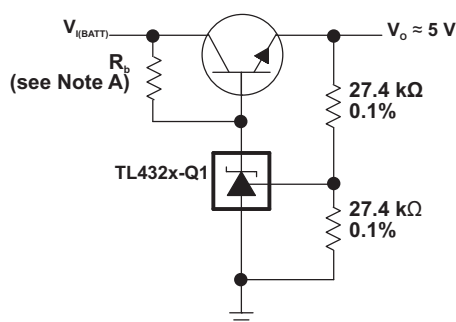


Figure 23. Precision 5-V 1.5-A Regulator



A. R_b should provide cathode current ≥ 1 mA to the TL432x-Q1.

Figure 24. Efficient 5-V Precision Regulator

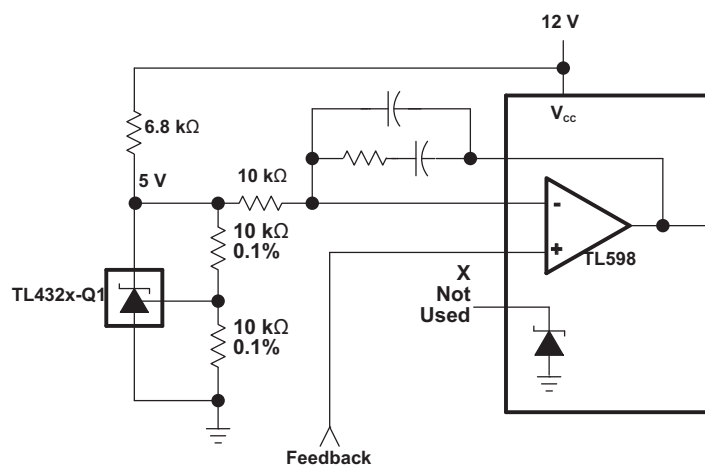
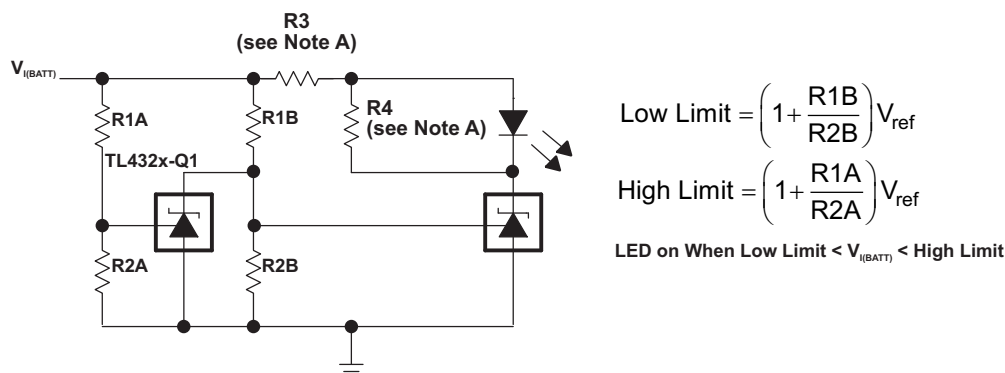


Figure 25. PWM Converter With Reference

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- A. R3 and R4 are selected to provide the desired LED intensity and cathode current ≥ 1 mA to the TL432x-Q1 at the available $V_{I(BATT)}$.

Figure 26. Voltage Monitor

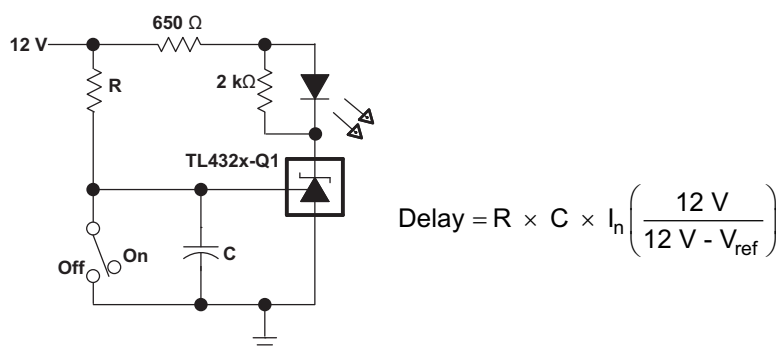


Figure 27. Delay Timer

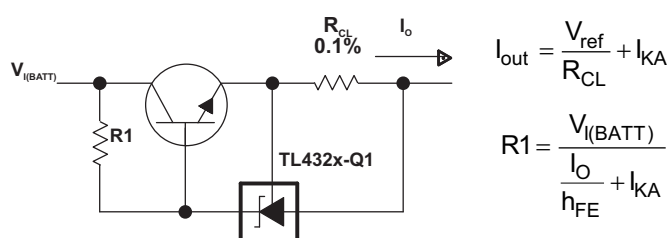


Figure 28. Precision Current Limiter

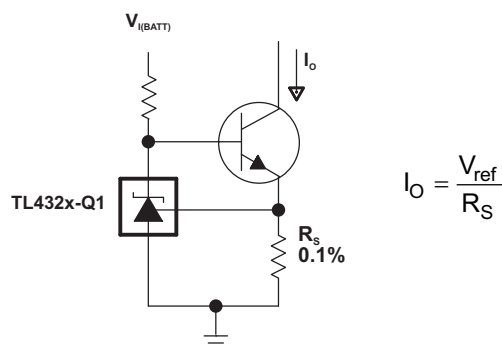


Figure 29. Precision Constant-Current Sink

REVISION HISTORY

Changes from Original (November, 2008) to Revision A	Page
• Added AEC-Q100 info to features	1
• Added ESD ratings information to recommended operating conditions table	3

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
TL432AQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	TOIQ	Samples
TL432BQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	TOHQ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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PACKAGE OPTION ADDENDUM

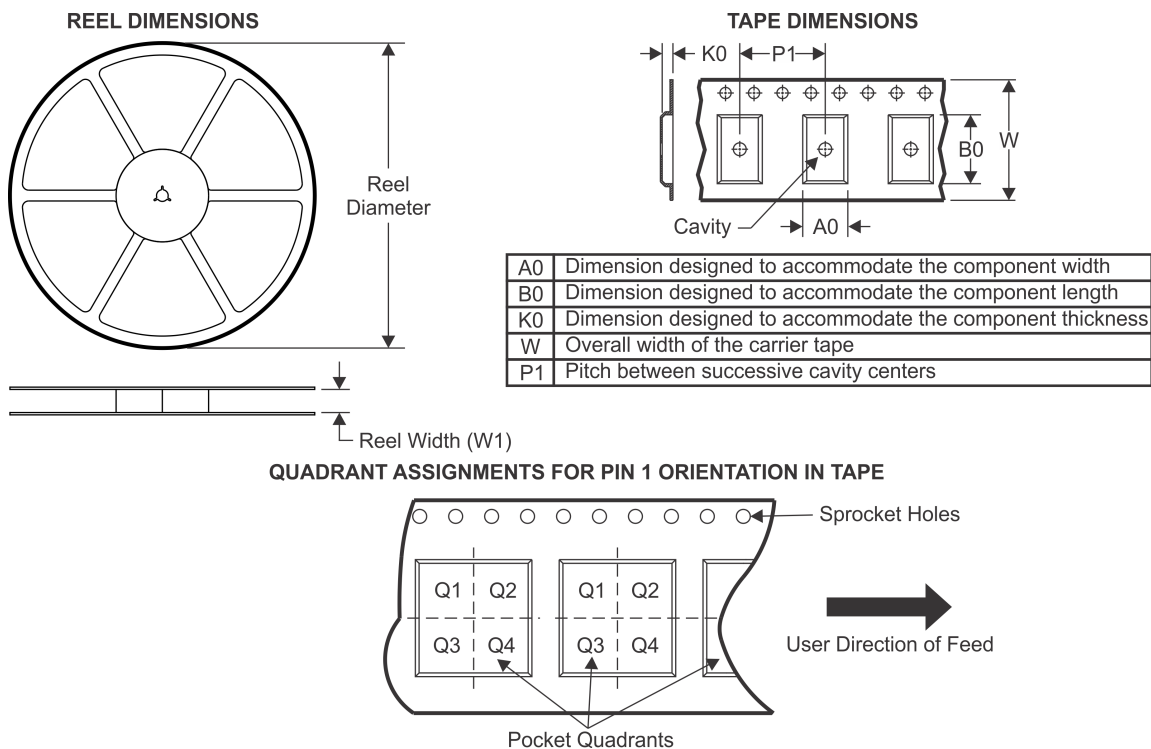
11-Apr-2013

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- Catalog: [TL432A](#), [TL432B](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

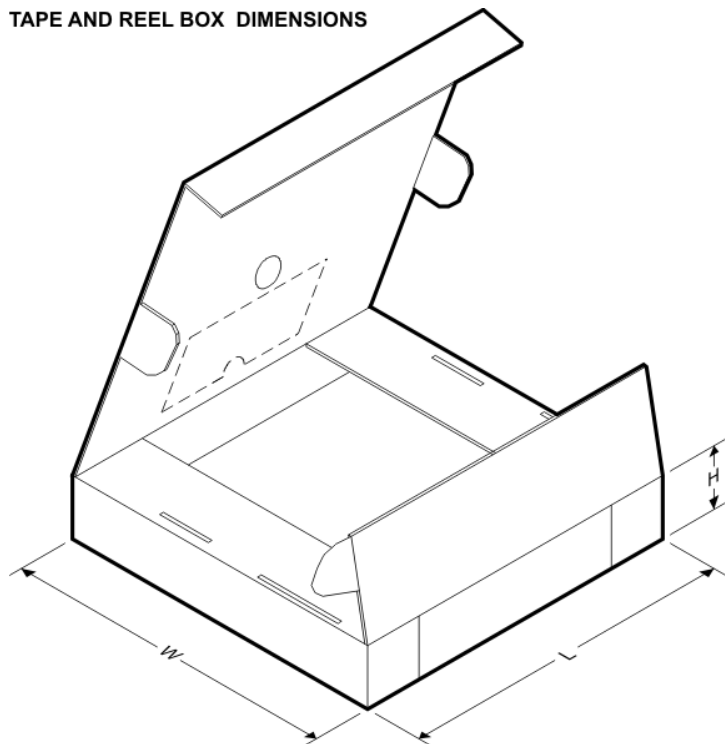
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL432AQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
TL432BQDBZRQ1	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



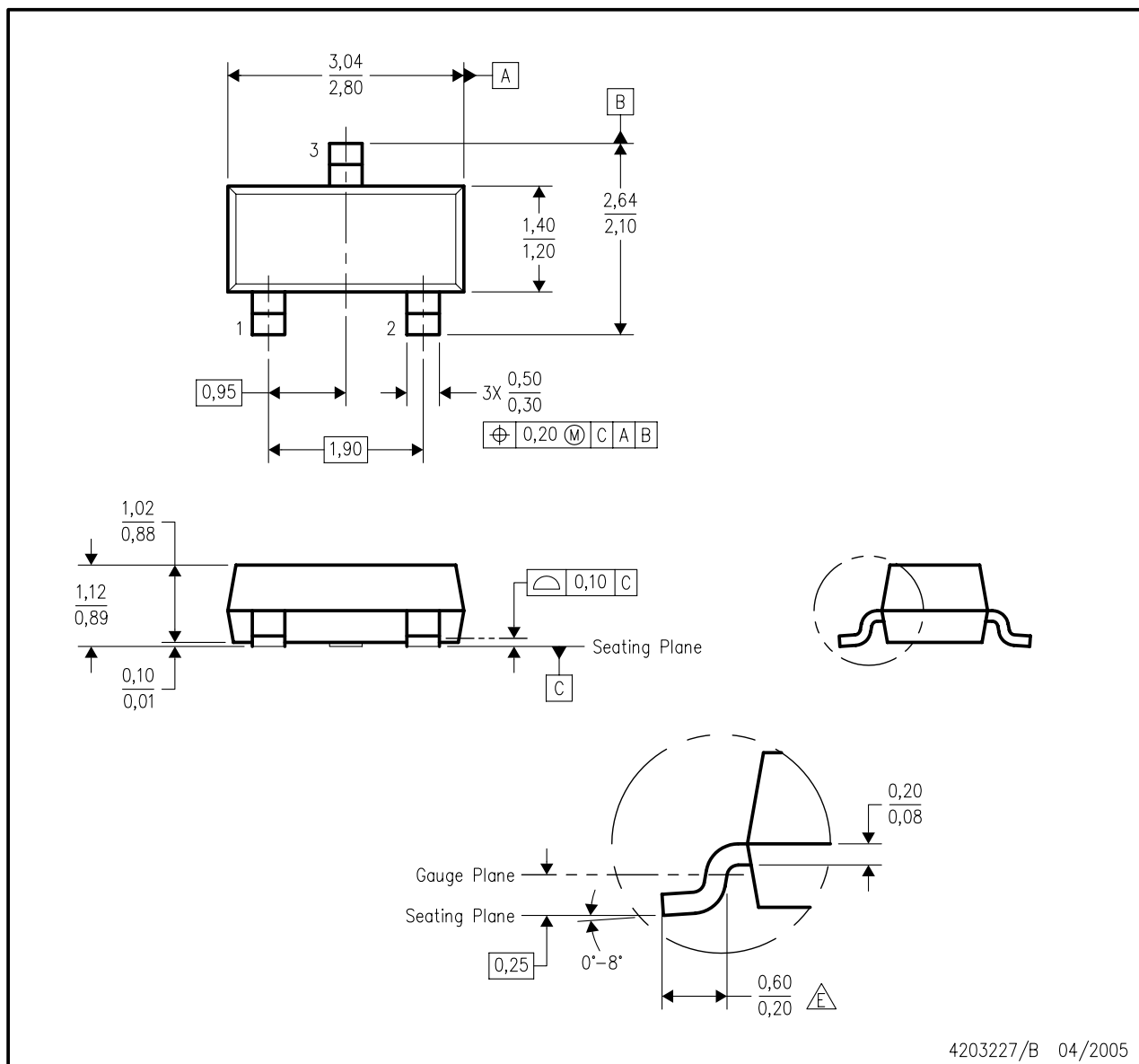
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL432AQDBZRQ1	SOT-23	DBZ	3	3000	203.0	203.0	35.0
TL432BQDBZRQ1	SOT-23	DBZ	3	3000	203.0	203.0	35.0

MECHANICAL DATA

DBZ (R-PDSO-G3)

PLASTIC SMALL-OUTLINE

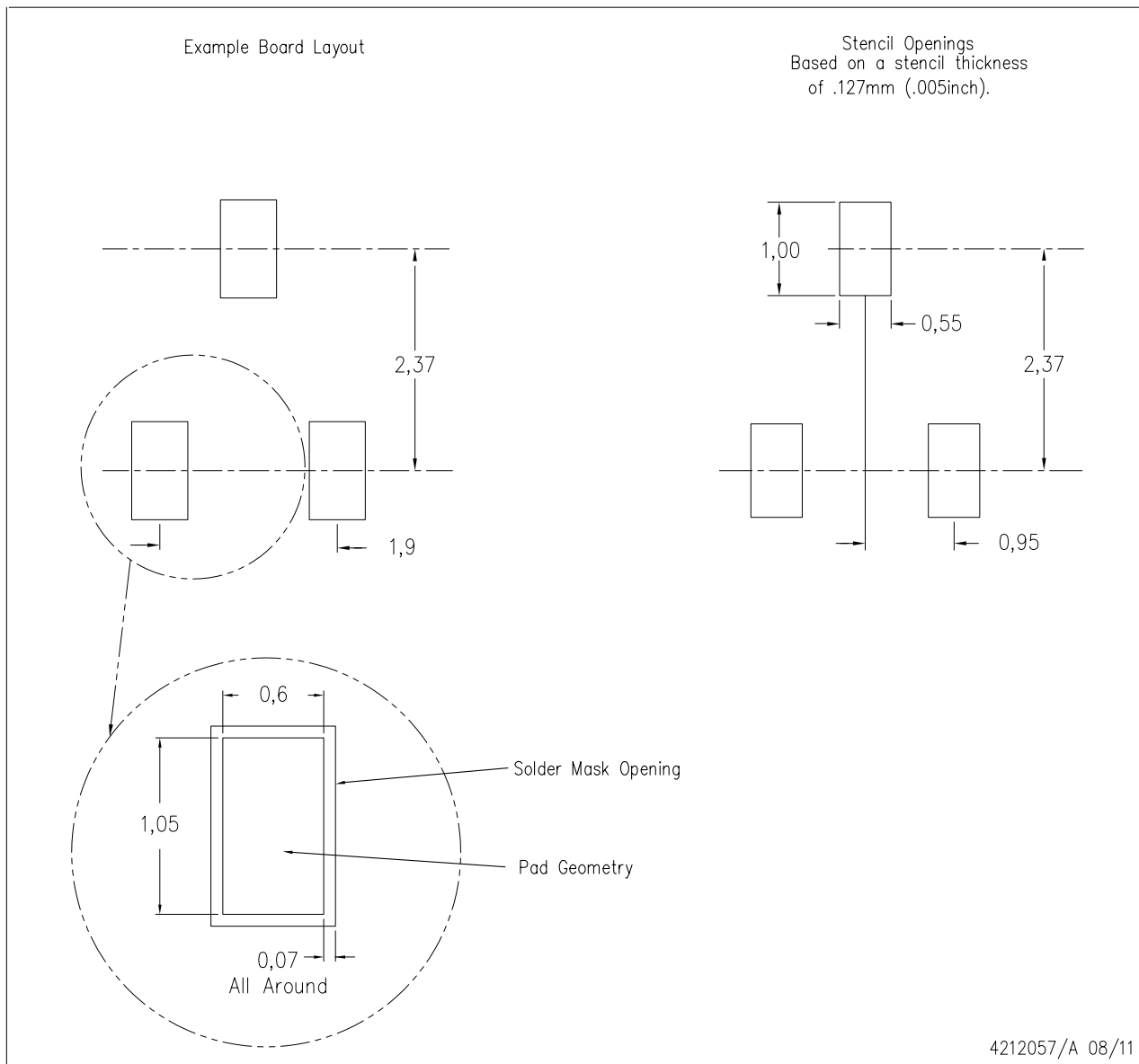


- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Lead dimensions are inclusive of plating.
 - Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.
- Falls within JEDEC TO-236 variation AB, except minimum foot length.

LAND PATTERN DATA

DBZ (R-PDSO-G3)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
 - D. Publication IPC-7351 is recommended for alternate designs.
 - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

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